

# **DATASHEET**

Technical Data Sheet
Top View LED
SS67-21C/B/L219/TR8(WW)

#### **Features**

- Low forward voltage.
- Compatible with infrared and vapor phase reflow solder process.
- Package in 8mm tape on 7" diameter reels.
- Size of emitting area 0.350mm \* 0.240mm
- Pb free
- Black Colored PLCC-2 package
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

### **Description**

• The SS67-21C/B/L219/TR8(WW) is a red LED , due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the ideal for light pipe application.

#### **Applications**

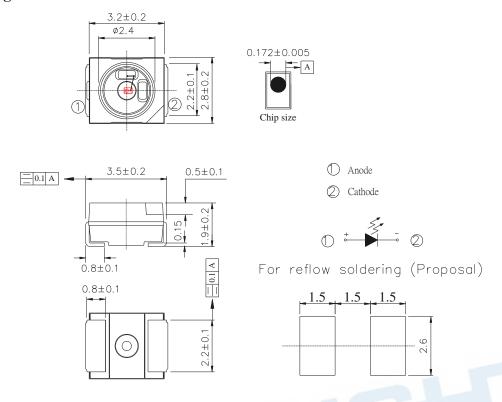
• Sensor applications

#### **Device Selection Guide**

Device No.	Device No. Chip Material		Lens Color	
SS67-21C/B/L219/TR8(WW)	AlInGaP/GaAs	Black	Water clear	



## **Package Dimensions**



**Notes:** 1.All dimensions are in millimeters 2.Tolerances unless dimensions  $\pm 0.1$ mm

## **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I <sub>F</sub>	50	mA
Reverse Voltage	$V_R$	5	V
Surge current(t=10µs)	I <sub>FSM</sub>	1	А
Operating Temperature	$T_{opr}$	-40 ~ +100	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C
Thermal resistance junction to ambient mounted on PC-board	$R_{thJA}$	330	K/W
Thermal resistance junction to soldering point mounted on metal block	R <sub>thJS</sub>	210	K/W
Soldering Temperature *1	$T_{sol}$	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	Pc	125	mW

**Notes:** \*1:Soldering time ≤ 10 seconds.

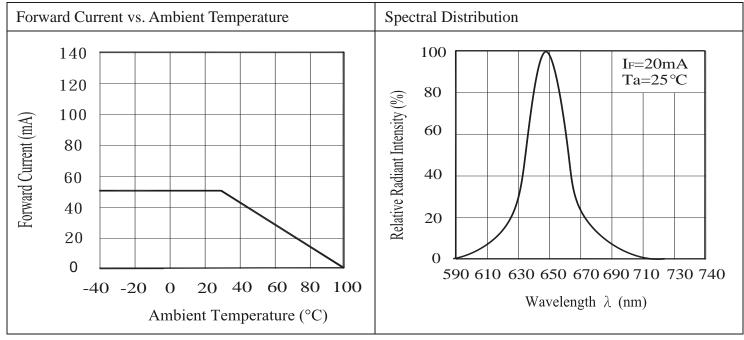


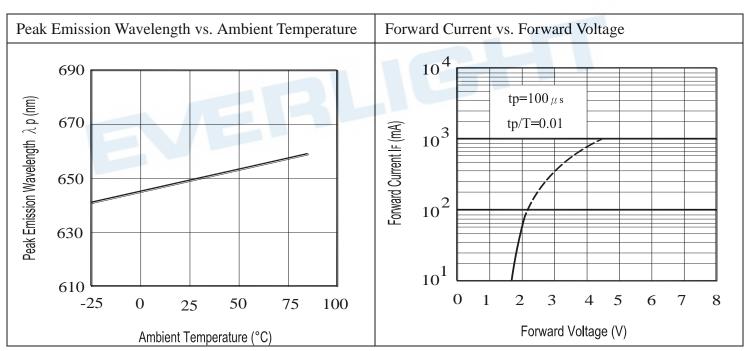
## Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Radiant Intensity	I <sub>E</sub> -	0.20	0.50	1.00	mW/sr	I <sub>F</sub> =20mA
		0.63	1.40	2.80	mW/sr	I <sub>F</sub> =50mA
Total Radiated Power	Po		4.00			I <sub>F</sub> =50mA
Peak Wavelength	λp		648		nm	I <sub>F</sub> =50mA
Dominant wavelength	λ <sub>d</sub>	635	637	645	nm	I <sub>F</sub> =50mA
Spectral Bandwidth	Δλ		20		nm	I <sub>F</sub> =20mA
Forward Voltage	V <sub>F</sub>	1.40			V	I <sub>F</sub> =10μA
			1.90	2.20	V	I <sub>F</sub> =20mA
	_		2.10	2.60	V	I <sub>F</sub> =50mA
Reverse Current	I <sub>R</sub>			10	nA	V <sub>R</sub> =5V
View Angle	2θ <sub>1/2</sub>		120		Deg.	I <sub>F</sub> =20mA
Active chip area	А		0.084		$mm^2$	
Dimensions of the active chip area	L*W		0.350*0.240		mm*mm	L.

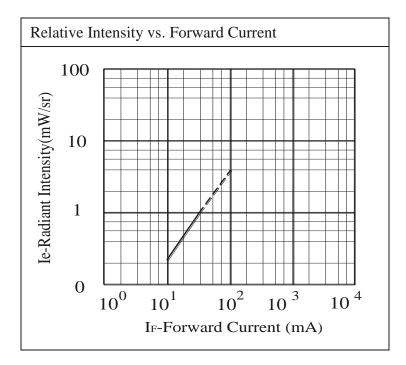


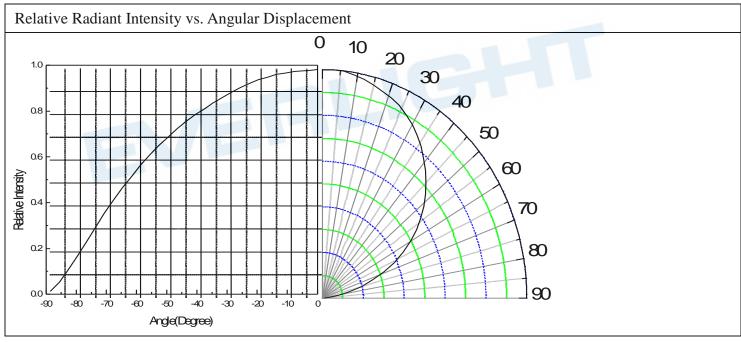
### Typical Electrical/Optical/Characteristics Curves













#### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

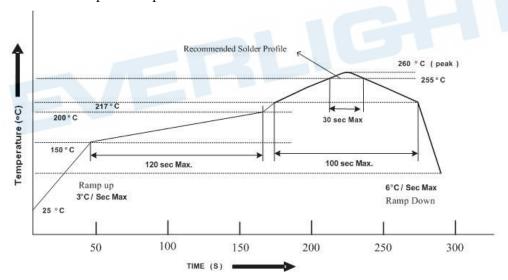
#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for Min 24 hours.

### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

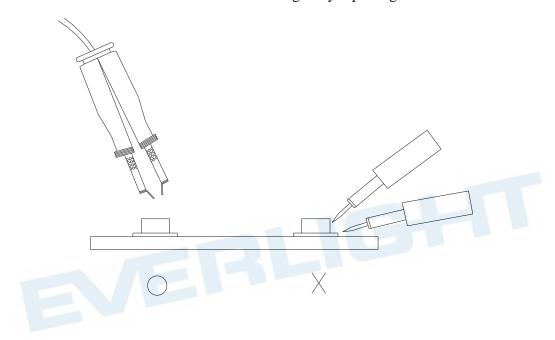


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

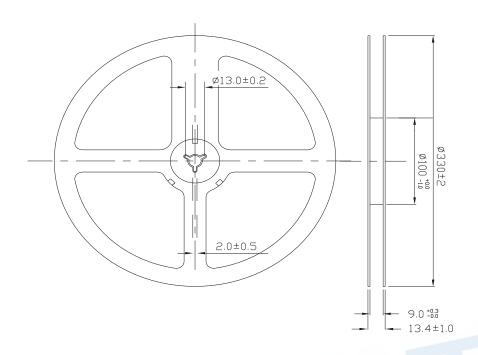
## 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



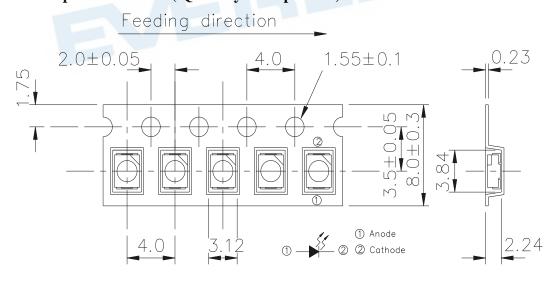


## **Package Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

## Carrier Tape Dimensions : (Quantity: 2000pcs/reel)

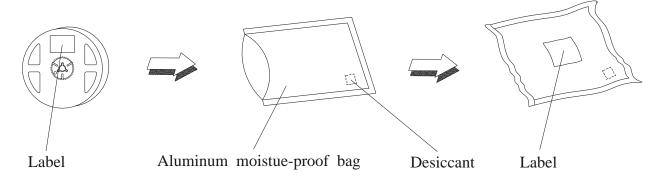


TOLERANCES UNLESS DIMENSION±0.1 ANGLE±0.5 UNIT:mm

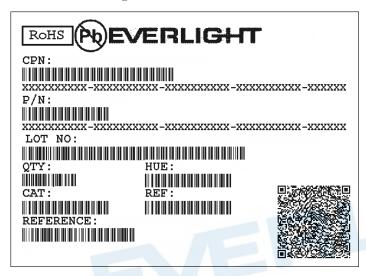
**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm



## **Packing Procedure**



## **Label Form Specification**



CPN: Customer's Production Number

P/N : Production Number OTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

**REF: Reference** 

LOT No: Lot Number

MADE IN TAIWAN: Production Place

#### **DISCLAIMER**

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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